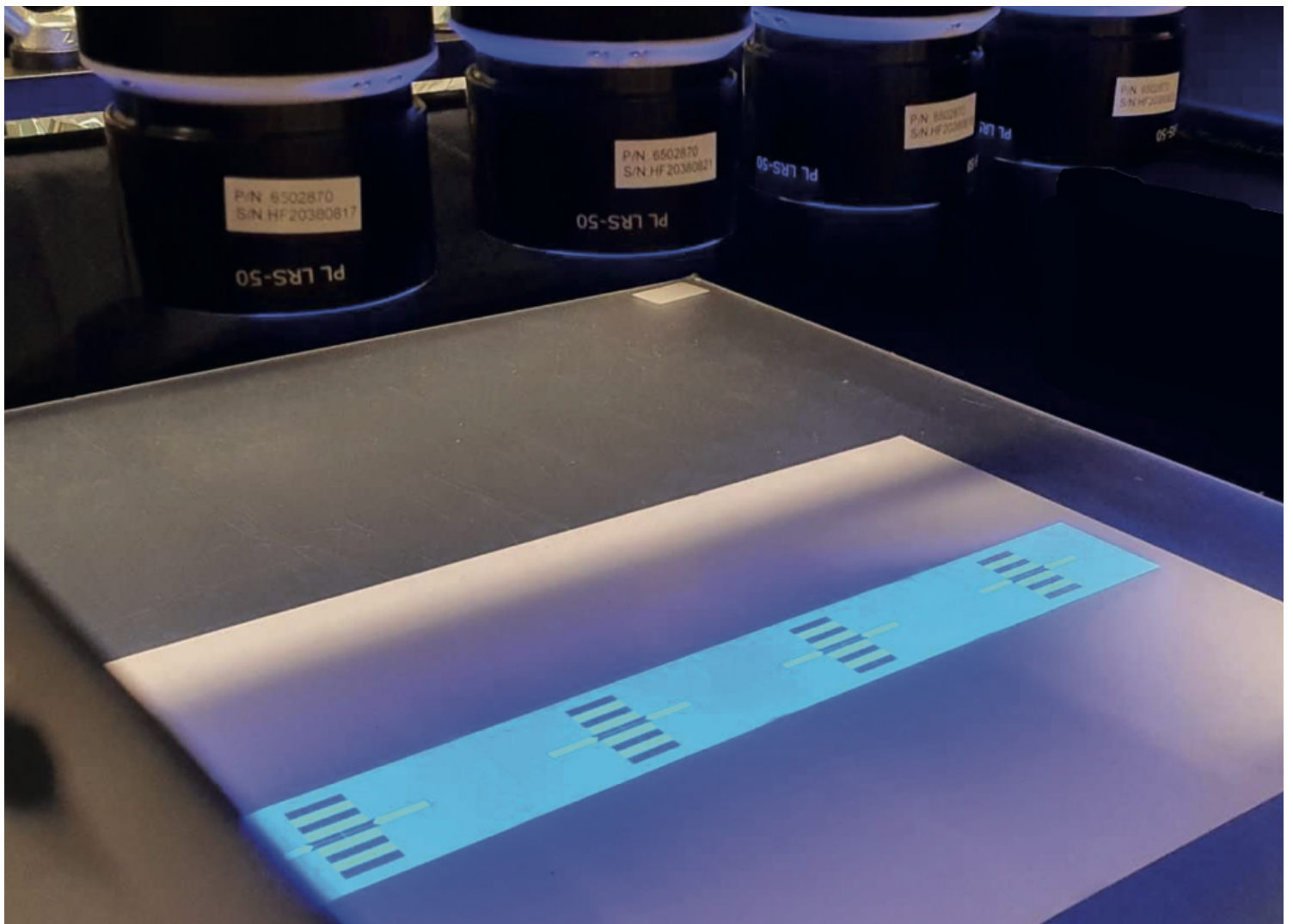


# VISITECH SHOWCASING HIGH-VOLUME AM SUBSYSTEM IN ACTION AT AMUG

*Posted on March 30, 2022*

At AMUG 2022 in Chicago, our US team is on-site to show you our high-volume DLP® stereolithography stacked multi-head subsystem – in action! The system is managed by our integrated LAMA software that supports both stacked and dynamic operation of multiple projectors.



In addition, our team will answer your questions about the all-new high-power micro-SLA (LRS- $\mu$ SLA) platform, our groundbreaking Direct Image Sintering (DIS) subsystem using our high-power infrared projector, and our latest high-performance static UV projectors – such as the LRS-4KA and LRS-WQ.

## **From delicate to ultra-large builds**

Our solutions enable machine builders to build machines capable of printing the most delicate 2-micron parts – and scrolling subsystems that allow ultra-large build areas of 1 x 5 m.

## **20 years of expertise**

We look forward to discussing how you can leverage 20 years of industrial lithography and additive manufacturing expertise for your next machine design.

## **Meet our team at booth 91!**

Busy show schedule? **You can book a meeting with us in advance below!**